

# mSATA mini

## 3TE7 Series

**Customer:** \_\_\_\_\_  
**Customer**  
**Part**  
**Number:** \_\_\_\_\_  
**Innodisk**  
**Part**  
**Number:** \_\_\_\_\_  
**Innodisk**  
**Model Name:** \_\_\_\_\_  
**Date:** \_\_\_\_\_

<b>Innodisk Approver</b>	<b>Customer Approver</b>

**Total Solution For  
Industrial Flash Storage**

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## REVISION HISTORY

<b>Revision</b>	<b>Description</b>	<b>Date</b>
1.0	First Release	Mar., 2019
1.1	Update Performance Update RoHS Declaration of Conformity	Apr., 2019
1.2	Update Power Consumption Update SMART Feature Set	Oct., 2019
1.3	Add Version 2 & B models	Jan., 2020
1.4	Revised Part Number Rules	Sep., 2021

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# 1. Product Overview

## 1.1 Introduction of Innodisk mSATA mini 3TE7

Innodisk mSATA mini 3TE7 which is designed with mSATA mini form factor by JEDEC MO-300/MO-300B, supporting SATA III standard (6.0Gb/s), achieves excellent performance up to 4CH standard by cost effective controller with 4CH. Regarding of mechanical interference, Innodisk mSATA mini 3TE7 absolutely replaces the traditional hard disk and makes personal computer, in any field, smaller and easier.

With Innodisk L<sup>3</sup> FW architecture, combining our signature 4K mapping algorithm L<sup>2</sup> FW architecture with powerful LDPC technology, 3TE7 series has outstanding high IOPS, better data integrity and extended lifespan through reducing the bad block number happening.

For real industrial application, 3TE7 series is built in thermal sensor to monitor the environment temperature. iData Guard, the power loss management mechanism developed by Innodisk, ensures data integrity while power sudden loss happened.

## 1.2 Product View and Models

Innodisk mSATA mini 3TE7 is available in follow capacities within 3D NAND flash ICs.

[mSATA mini 3TE7 32GB](#)   [mSATA mini 3TE7 64GB](#)   [mSATA mini 3TE7 128GB](#)

[mSATA mini 3TE7 256GB](#)   [mSATA mini 3TE7 512GB](#)

TSOP

BGA



Figure 1: Innodisk mSATA mini 3TE7

## 1.3 SATA Interface

Innodisk mSATA mini 3TE7 supports SATA III(6.0Gb/s) interface, and compliant with SATA I (1.5Gb/s) and SATA II(3.0Gb/s).

## 2. Product Specifications

### 2.1 Capacity and Device Parameters

mSATA mini 3TE7 device parameters are shown in Table 1.

**Table 1: Device parameters**

Capacity	LBA	Cylinders	Heads	Sectors	User Capacity(GB)
32GB	53742528	16383	16	63	25.6
64GB	117231408	16383	16	63	55.9
128GB	234441648	16383	16	63	111.8
256GB	468862128	16383	16	63	223.6
512GB	937703088	16383	16	63	447.1

### 2.2 Performance

Burst Transfer Rate: 6.0Gbps

**Table2: Performance**

Capacity	32GB	64GB	128GB	256GB	512GB
Sequential Read (max.)	180	355	510	510	560
Sequential Write (max.)	35	75	150	300	330
4KB Random** Read (QD32)	11000	23000	43000	72000	85000
4KB Random** Write (QD32)	9000	18000	36000	67000	70000

Note: the information is based on CrystalDiskMark 5.1.2 with file size 1000MB test pattern

### 2.3 Electrical Specifications

#### 2.3.1 Power Requirement

**Table 3: Innodisk mSATA mini 3TE7 Power Requirement**

Item	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	+3.3 DC +- 5%	V

## 2.3.2 Power Consumption

**Table 4: Power Consumption**

Mode	Power Consumption (mA)				
	32GB	64GB	128GB	256GB	512GB
Read	250	300	360	360	460
Write	250	300	330	415	560
Idle	205	210	215	215	240
Boot-Up Peak	240	240	270	270	390

\* Target: mSATA mini 3TE7

## 2.4 Environmental Specifications

### 2.4.1 Temperature Ranges

**Table 5: Temperature range for mSATA mini 3TE7**

Temperature	Range
Operating	Standard Grade: 0°C to +70°C
	Industrial Grade: -40°C to +85°C
Storage	-40°C to +85°C

### 2.4.2 Humidity

Relative Humidity: 10-95%, non-condensing

### 2.4.3 Shock and Vibration

**Table 6: Shock/Vibration Testing for mSATA mini 3TE7**

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

### 2.4.4 Mean Time between Failures (MTBF)

Table 7 summarizes the MTBF prediction results for various mSATA mini 3TE7 configurations. The analysis was performed using a RAM Commander™ failure rate prediction.

- **Failure Rate:** The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- **Mean Time between Failures (MTBF):** A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

**Table 7: mSATA mini 3TE7 MTBF**

<b>Product</b>	<b>Condition</b>	<b>MTBF (Hours)</b>
Innodisk mSATA mini 3TE7	Telcordia SR-332 GB, 25°C	>3,000,000

## **2.5 CE and FCC Compatibility**

mSATA mini 3TE7 conforms to CE and FCC requirements.

## **2.6 RoHS Compliance**

mSATA mini 3TE7 is fully compliant with RoHS directive.

## 2.7 Reliability

Parameter		Value
Read Cycles		Unlimited Read Cycles
Flash endurance		3,000 P/E cycles
Wear-Leveling Algorithm		Support
Bad Blocks Management		Support
DIE RAID Recovery		Support
Error Correct Code		Support
<b>TBW* (Total Bytes Written) Units: TB</b>		
Capacity	Sequential workload	Client workload
32GB	84.3	37.5
64GB	168.6	75
128GB	337.2	150
256GB	674.4	250
512GB	1348.8	500
<p>* Note:</p> <ol style="list-style-type: none"> <li>Sequential: Mainly sequential write, tested by Vdbench.</li> <li>Client: Follow JESD218 Test method and JESD219A Workload, tested by ULINK. (The capacity lower than 64GB client workload is not specified in JEDEC219A, the values are estimated.)</li> <li>Based on out-of-box performance.</li> </ol>		

## 2.8 Transfer Mode

mSATA mini 3TE7 support following transfer mode:

Serial ATA III 6.0Gbps

Serial ATA II 3.0Gbps

Serial ATA I 1.5Gbps

## 2.9 Pin Assignment

Innodisk mSATA mini 3TE7 uses a standard SATA pin-out. See Table 8 for mSATA mini 3TE7 pin assignment.

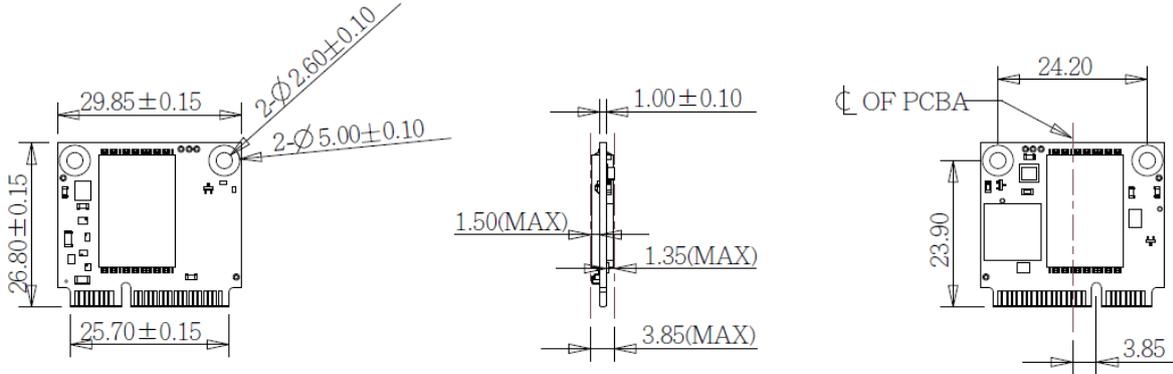
**Table 8: Innodisk mSATA mini 3TE7 Pin Assignment**

Signal Name	Pin #	Pin #	Signal Name
GND	51	52	+3.3V
DAS	49	50	GND
NC	47	48	NC
NC	45	46	NC
NC	43	44	DEVSLP
+3.3V	41	42	NC
+3.3V	39	40	GND
GND	37	38	NC
GND	35	36	NC
RX+	33	34	GND
RX-	31	32	NC
GND	29	30	NC
GND	27	28	NC
TX-	25	26	GND
TX+	23	24	+3.3V
GND	21	22	NC
NC	19	20	NC
NC	17	18	GND
GND	15	16	NC
NC	13	14	NC

NC	11	12	NC
GND	9	10	NC
NC	7	8	NC
NC	5	6	NC
NC	3	4	GND
NC	1	2	+3.3V

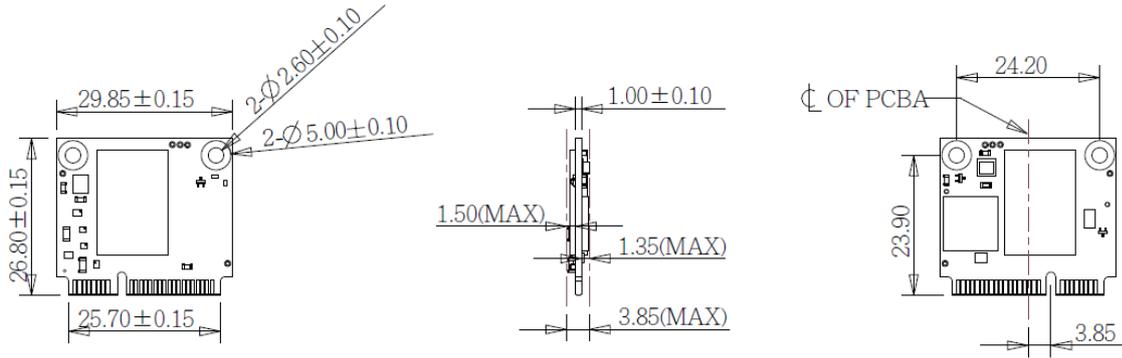
**2.10 Mechanical Dimensions**

TSOP



TOLERANCE:  $\pm 0.15$ mm  
UNIT: mm

BGA



TOLERANCE:  $\pm 0.15$ mm  
UNIT: mm

### **2.11 Assembly Weight**

An Innodisk mSATA mini 3TE7 with flash ICs, 32GB's weight is 6 grams approximately.

### **2.12 Seek Time**

Innodisk mSATA mini 3TE7 is not a magnetic rotating design. There is no seek or rotational latency required.

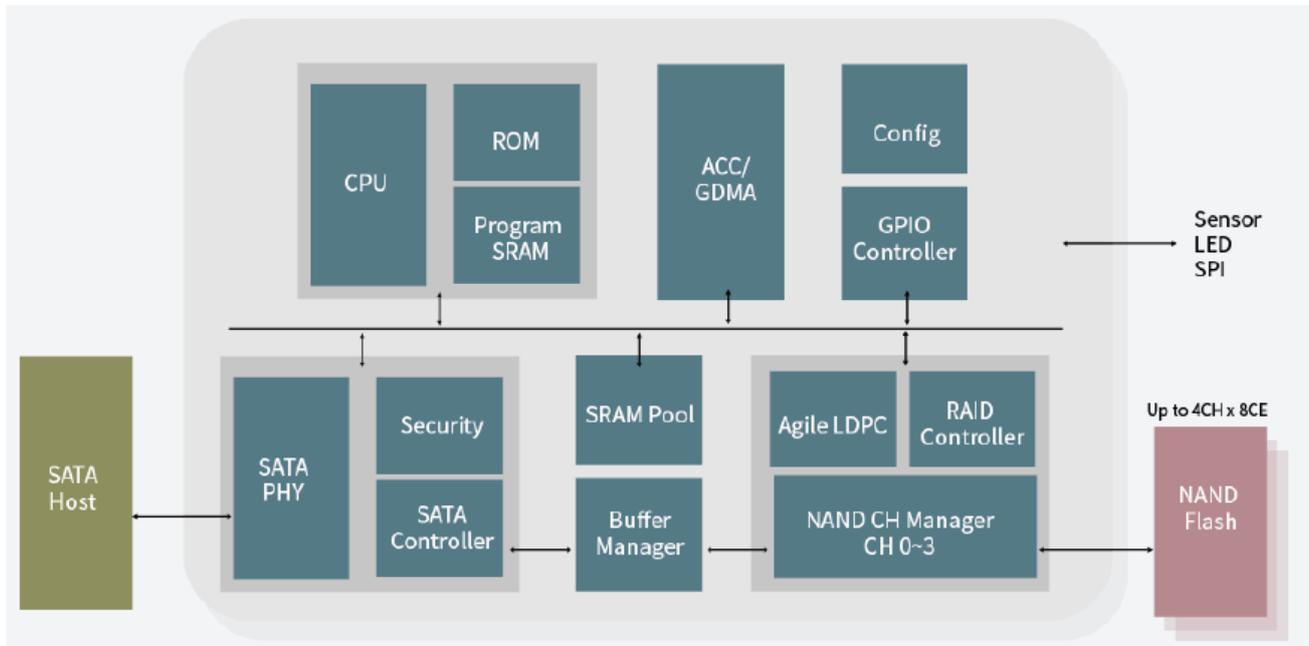
### **2.13 NAND Flash Memory**

Innodisk mSATA mini 3TE7 uses 3D TLC NAND flash memory, with 3,000 program & erase cycles, which is non-volatility, high reliability and high speed memory storage.

## 3. Theory of Operation

### 3.1 Overview

Figure 2 shows the operation of Innodisk mSATA mini 3TE7 from the system level, including the major hardware blocks.



**Figure 2: Innodisk mSATA mini 3TE7 Block Diagram**

Innodisk mSATA mini 3TE7 integrates a SATA III controller and NAND flash memories. Communication with the host occurs through the host interface, using the standard ATA protocol. Communication with the flash device(s) occurs through the flash interface.

### 3.2 SATA III Controller

Innodisk mSATA mini 3TE7 is designed with a SATA III 6.0Gbps (Gen. 3) controller. The Serial ATA physical, link and transport layers are compliant with Serial ATA Gen 1, Gen 2 and Gen 3 specification (Gen 3 supports 1.5Gbps/3.0Gbps/6.0Gbps data rate). The controller has 4 channels for flash interface.

### 3.3 Error Detection and Correction

Innodisk mSATA mini 3TE7 is designed with hardware LDPC ECC engine with hard-decision and Soft-decision decoding. Low-density parity-check (LDPC) codes have excellent error correcting Performance close to the Shannon limit when decoded with the belief-propagation (BP) algorithm using soft-decision information.

### 3.4 Wear-Leveling

Flash memory can be erased within a limited number of times. This number is called the **erase cycle limit** or **write endurance limit** and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

Innodisk mSATA mini 3TE7 uses a static wear-leveling algorithm to ensure that consecutive writes of a specific sector are not written physically to the same page/block in the flash. This spreads flash media usage evenly across all pages, thereby extending flash lifetime.

### 3.5 Bad Blocks Management

Bad Blocks are blocks that contain one or more invalid bits whose reliability are not guaranteed. The Bad Blocks may be presented while the SSD is shipped, or may develop during the life time of the SSD. When the Bad Blocks is detected, it will be flagged, and not be used anymore. The SSD implement Bad Blocks management, Bad Blocks replacement, Error Correct Code to avoid data error occurred. The functions will be enabled automatically to transfer data from Bad Blocks to spare blocks, and correct error bit.

### 3.6 iData Guard

Innodisk's iData Guard is a comprehensive data protection mechanism that functions before and after a sudden power outage to SSD. Low-power detection terminates data writing before an abnormal power-off, while table-remapping after power-on deletes corrupt data and maintains data integrity. Innodisk's iData Guard provides effective power cycling management, preventing data stored in flash from degrading with use.

### 3.7 Garbage Collection

Garbage collection is used to maintain data consistency and perform continual data cleansing on SSDs. It runs as a background process, freeing up valuable controller resources while sorting good data into available blocks, and deleting bad blocks. It also significantly reduces write operations to the drive, thereby increasing the SSD's speed and lifespan.

### 3.8 Trim

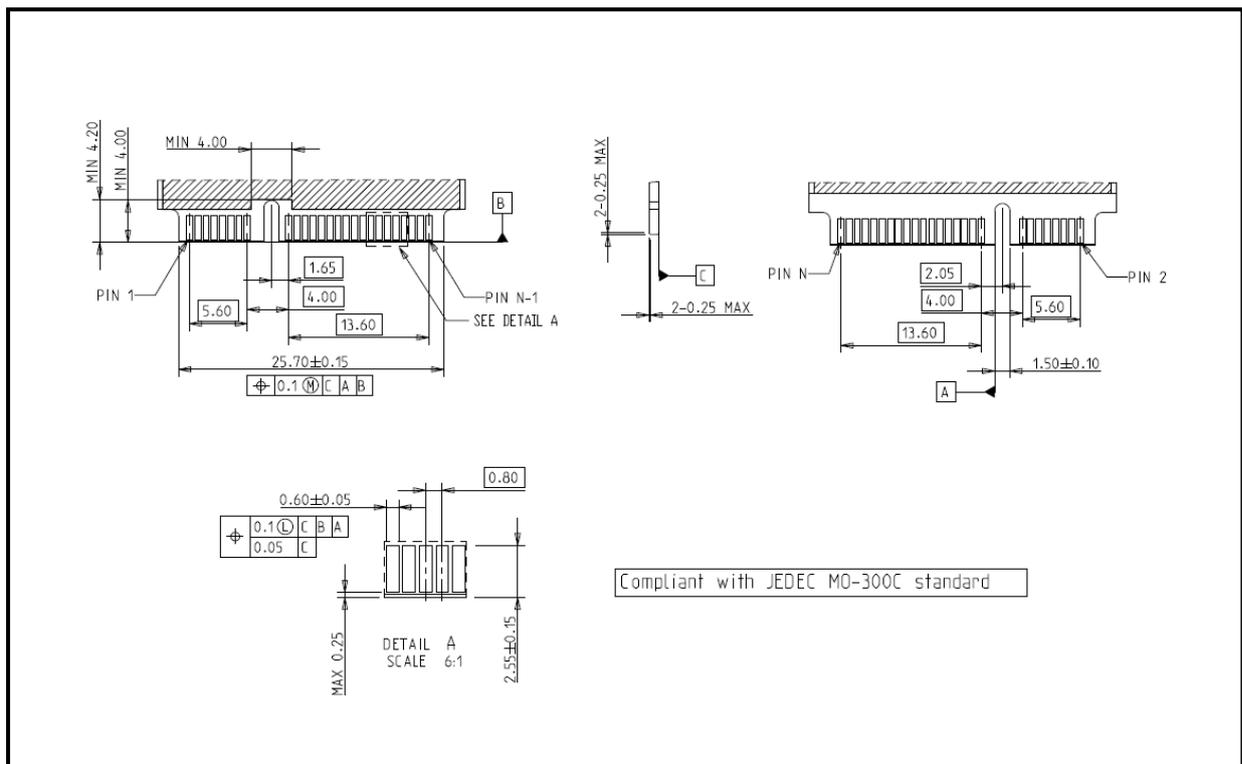
The Trim command is designed to enable the operating system to notify the SSD which pages no longer contain valid data due to erases either by the user or operating system itself. During a delete operation, the OS will mark the sectors as free for new data and send a Trim command to the SSD to mark them as not containing valid data. After that the SSD knows not to preserve the contents of the block when writing a page, resulting in less write amplification with fewer writes to the flash, higher write speed, and increased drive life.

### 3.9 iPower Guard

iPower Guard technology is a set of preventive measures that protect the SSD in an unstable power supply environment. This comprehensive package comprises safeguards for startup and shutdown to maintain device performance and ensure data integrity.

## 4. Installation Requirements

### 4.1 mSATA mini 3TE7 Pin Directions



**Figure 3: Signal Segment and Power Segment**

### 4.2 Electrical Connections for mSATA mini 3TE7

A Serial ATA device may be either directly connected to a host or connected to a host through an adaptor card. The SATA interface has a separate connector for the power supply. Please refer to the pin description for further details.

### 4.3 Device Drive

No additional device drives are required. The Innodisk mSATA mini 3TE7 can be configured as a boot device.

## 5. SMART Feature Set

Innodisk 3TE7 series support the SMART command set and defines some vendor-specific data to report SMART attributes of SSD.

**Table 9: SMART command**

Value	Command	Value	Command
D0h	Read Data	D5h	Read Log
D1h	Read Attribute Threshold	D6h	Return Status
D2h	Enable/Disable Auto save	D8h	Enable SMART Operations
D3h	Save Attribute Values	D9h	Disable SMART Operations
D4h	Execute OFF-LINE Immediate	DAh	Return Status

### 5.1 SMART Attributes

Innodisk 3TE7 series SMART data attributes are listed in following table.

**Table 10: SMART attribute**

Attribute ID (hex)	Value	Raw Attribute Value						Rsv	Attribute Name
01	X								Read Error Rate
05	X	LSB	MSB	00	00	00	00	00	Later Bad
09	LSB	LSB	MSB	00	00	00	00	00	Power-On hours Count
0C	LSB	LSB	MSB	00	00	00	00	00	Drive Power Cycle Count
A3	X	LSB			MSB	00	00	00	Total Bad Block Count
A5	LSB	LSB			MSB	00	00	00	Max Erase count
A7	LSB	LSB			MSB	00	00	00	Avg Erase count
A9	LSB	LSB	00	00	00	00	00	00	Device Life
AA	X	LSB	MSB	00	00	00	00	00	Spare Block Count
AB	LSB	LSB	MSB	00	00	00	00	00	Program fail count
AC	LSB	LSB	MSB	00	00	00	00	00	Erase fail count
C0	LSB	LSB	MSB	00	00	00	00	00	Unexpected Power Loss Count

C2	LSB			MIN		MAX	00	00	Temperature
E5		ID 0	ID 1	ID 2	ID 3	ID 4	ID 5		Flash ID
EB			<b>MSB</b>	<b>LSB</b>	<b>MSB</b>	<b>LSB</b>	<b>MSB</b>	<b>LSB</b>	Later bad block info ( <b>Read/Write/Erase</b> )
F1	00	LSB			MSB	00	00	00	Total LBA written(LBA=32MB)
F2	00	LSB			MSB	00	00	00	Total LBA read(LBA=32MB)

# 6. Part Number Rule

CODE	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
	D	E	M	S	M	-	C	1	2	D	K	1	E	C	1	Q	F	-	X	X	X
<b>Definition</b>																					
<b>Code 1<sup>st</sup> (Disk)</b>											<b>Code 13<sup>th</sup> (Flash Mode)</b>										
D : Disk											E: 64 layers 3D TLC										
<b>Code 2<sup>nd</sup> Feature Set</b>											<b>Code 14<sup>th</sup> (Operation Temperature)</b>										
E: Embedded											C: Standard Grade (0°C ~ +70°C)										
											W: Industrial Grade (-40°C ~ +85°C)										
<b>Code 3<sup>rd</sup> ~ 5<sup>th</sup> (Form Factor)</b>											<b>Code 15<sup>th</sup> (Internal control)</b>										
MSM: mSATA mini											1/A: First PCB version										
											2/B: Second PCB version										
<b>Code 7<sup>th</sup> ~9<sup>th</sup> (Capacity)</b>											<b>Code 16<sup>th</sup> (Channel of data transfer)</b>										
32G: 32GB											S: Single Channel										
64G: 64GB											D: Dual Channels										
A28: 128GB											Q: Quad Channels										
B56: 256GB																					
C12: 512GB											<b>Code 17<sup>th</sup> (Flash Type)</b>										
<b>Code 10<sup>th</sup> ~12<sup>th</sup> (Controller)</b>											F: Kioxia 3D TLC										
DK1: SATA 3TE7											<b>Code 19<sup>th</sup>~21<sup>th</sup> (Customized Code)</b>										

## RoHS 自我宣告書 (RoHS Declaration of Conformity)

### Manufacturer Product: All Innodisk EP products

- 一、宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟 2011/65/EU 及 (EU) 2015/863 關於 RoHS 之規範要求。

Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.

- 二、本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。

Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄰苯二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

### 立保證書人 (Guarantor)

Company name 公司名稱：Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人：Randy Chien 蔡川勝

Company Representative Title 公司代表人職稱：Chairman 董事長

Date 日期：2018 / 07 / 01



宜鼎國際股份有限公司  
Innodisk Corporation

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: <http://www.innodisk.com/>

## REACH Declaration of Conformity

### Manufacturer Product: All Innodisk EM Flash and Dram products

1. 宜鼎國際股份有限公司（以下稱本公司）特此保證此售予貴公司之產品，皆符合歐盟化學品法案(Registration , Evaluation and Authorization of Chemicals ; (EC) No 1907/2006 REACH) 以及附錄 XIV 中的限用物質之規定 (<http://www.echa.europa.eu/de/candidate-list-table> last updated: 12/01/2017 , SVHC's 173 )。

所提供之產品包含：(1) 產品或產品所使用到的所有原物料；(2)包裝材料；(3)設計、生產及重工過程中所使用到的所有原物料。

We Innodisk Corporation hereby declare that our products are in compliance with the requirements according to the (EC) No 1907/2006 REACH Regulation and restricted substances in Annex XIV (<http://www.echa.europa.eu/de/candidate-list-table> last updated: 12/01/2017 , SVHC's 173 ).

Products include : 1) Product and raw material used by the product ; 2) Packaging material ; 3) Raw material used in the process of design, production and rework.

2. 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。InnoDisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

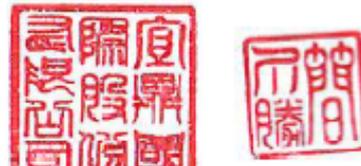
### 立保證書人 (Guarantor)

Company name 公司名稱： InnoDisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人： Randy Chien 簡川勝

Company Representative Title 公司代表人職稱： Chairman 董事長

Date 日期： 2017 / 02 / 08





## VERIFICATION OF COMPLIANCE

*This Verification of Compliance is hereby issued to the below named company. The test results of this report relate only to the tested sample identified in this report.*

**Technical Standard: EMC DIRECTIVE 2014/30/EU  
(EN55022 / EN55024)**

### General Information

Applicant: Innodisk Corporation  
5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist.,  
New Taipei City 22161, Taiwan (R.O.C)

### Product Description

EUT Description: mSATA  
Brand Name: Innodisk  
Model Number: mSATA 3\$\*#-&  
\$:Flash type: (S:SLC, I:iSLC, M:MLC, T:3D TLC)  
\*:Product line: (E:Embedded, G:EverGreen, R:InnoRobust)  
#:Product Generation: (empty, 0~9)  
&:Product line: (empty, P:Plus)

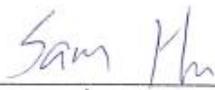
### Measurement Standard

EN 55022: 2010 / AC: 2011  
EN 61000-3-2: 2014  
EN 61000-3-3: 2013  
EN 55024: 2010 + A1: 2015  
(IEC 61000-4-2: 2008; IEC 61000-4-3: 2006 + A1: 2007 + A2: 2010; IEC 61000-4-4: 2012;  
IEC 61000-4-5: 2014; IEC 61000-4-6: 2013; IEC 61000-4-8: 2009; IEC 61000-4-11: 2004)

### Measurement Facilities

Xindian Lab.: **Compliance Certification Services Inc.**  
No.163-1, Zhongsheng Rd., Xindian Dist., New Taipei City, 23151 Taiwan.  
Tel: +886-2-22170894 / Fax: +886-2-22171029

*This device has been shown to be in compliance with and was tested in accordance with the measurement procedures specified in the Standards & Specifications listed above and as indicated in the measurement report number: T161004D13-E*

  
\_\_\_\_\_  
Sam Hu / Assistant Manager  
Date: October 11, 2016



## VERIFICATION OF COMPLIANCE

*This Verification of Compliance is hereby issued to the below named company. The test results of this report relate only to the tested sample identified in this report.*

### Technical Standard: EMC DIRECTIVE 2014/30/EU (EN55032)

#### General Information

Applicant: Innodisk Corporation  
5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist.,  
New Taipei City 22161, Taiwan (R.O.C)

#### Product Description

EUT Description: mSATA  
Brand Name: Innodisk  
Model Number: mSATA 3S\*#-&  
S:Flash type: (S:SLC, I:iSLC, M:MLC, T:3D TLC)  
\*:Product line: (E:Embedded, G:EverGreen, R:InnoRobust)  
#:Product Generation: (empty, 0-9)  
&:Product line: (empty, P:Plus)

#### Measurement Standard

EN 55032: 2012 / AC: 2013  
CISPR 32: 2012

#### Measurement Facilities

Xindian Lab.: **Compliance Certification Services Inc.**  
No.163-1, Jhongsheng Rd., Xindian Dist., New Taipei City, 23151 Taiwan.  
Tel: +886-2-22170894 / Fax: +886-2-22171029

*This device has been shown to be in compliance with and was tested in accordance with the measurement procedures specified in the Standards & Specifications listed above and as indicated in the measurement report number: T161004D13-E*

*Sam Hu / Assistant Manager*

*Date: October 11, 2016*



## VERIFICATION OF COMPLIANCE

*This Verification of Compliance is hereby issued to the below named company. The test results of this report relate only to the tested sample identified in this report.*

**Technical Standard: FCC Part 15 Class B  
IC ICES-003**

### General Information

Applicant: Innodisk Corporation  
5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist.,  
New Taipei City 22161, Taiwan (R.O.C)

### Product Description

EUT Description: mSATA  
Brand Name: Innodisk  
Model Number: mSATA 3\$\*#-&  
\$:Flash type: (S:SLC, I:iSLC, M:MLC, T:3D TLC)  
\*:Product line: (E:Embedded, G:EverGreen, R:InnoRobust)  
#:Product Generation: (empty, 0~9)  
&:Product line: (empty, P:Plus)

### Measurement Facilities

Xindian Lab.: **Compliance Certification Services Inc.**  
No.163-1, Jhongsheng Rd., Xindian Dist., New Taipei City, 23151 Taiwan.  
Tel: +886-2-22170894 / Fax: +886-2-22171029

*This device has been shown to be in compliance with and was tested in accordance with the measurement procedures specified in the Standards & Specifications listed above and as indicated in the measurement report number: T161004D13-D*

*Sam Hu / Assistant Manager*

*Date: October 11, 2016*



## MSL Declaration of Conformity

1. Purpose: MSL (Moisture Sensitivity Levels) specification statement for all Innodisk products

2. Scope: For All Innodisk finish goods

3. Responsibilities: QA

4. Reference:

4.1 JEDEC, S-STD-020

4.2 JEDEC, J-STD-033

5. Description

5.1 Innodisk Products Level: All Innodisk products meet MSL Level 1

5.2 Floor Life Time: Refer following table

Level	Soak Requirements					
	Floor Life		Standard		Accelerated	
	Time	Cond degC%/RH	Time (hrs)	Cond degC%/RH	Time (hrs)	Cond degC%/RH
1	unlimited	<=30/85%	168+5/-0	85/85	n/a	n/a
2	1 year	<=30/60%	168+5/-0	85/60	n/a	n/a
2a	4 weeks	<=30/60%	696+5/-0	30/60	120+1/-0	60/60
3	168 hours	<=30/60%	192+5/-0	30/60	40+1/-0	60/60
4	72 hours	<=30/60%	96+2/-0	30/60	20+0.5/-0	60/60
5	48 hours	<=30/60%	72+2/-0	30/60	15+0.5/-0	60/60
5a	24 hours	<=30/60%	48+2/-0	30/60	10+0.5/-0	60/60
6	TOL	<=30/60%	TOL	30/60	n/a	60/60

Innodisk Corporation  
 Quality Assurance Div  
 Manager  
 Yi Chuan Chen  
 Date: 2018.09.21



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